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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

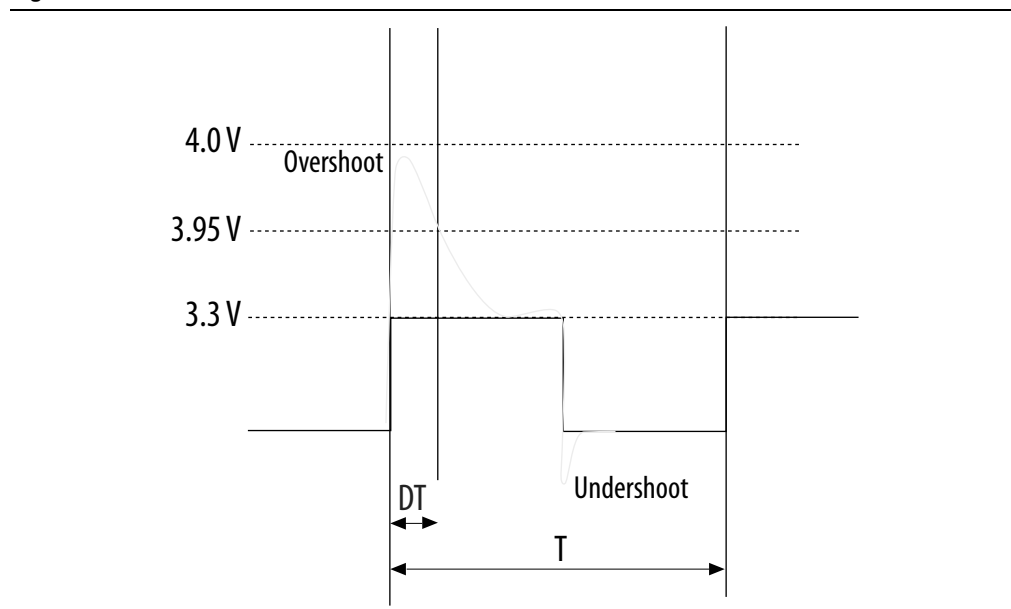
|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 128300  |
| Number of Logic Elements/Cells | 340000  |
| Total RAM Bits                 | 19456000  |
| Number of I/O                  | 600   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.82V ~ 0.88V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | -40°C ~ 100°C (TJ)  |
| Package / Case                 | 780-BBGA, FCBGA   |
| Supplier Device Package        | 780-HBGA (33x33)  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxma3e2h29i3ln">https://www.e-xfl.com/product-detail/intel/5sgxma3e2h29i3ln</a> |

Table 5 lists the maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage of device lifetime. The maximum allowed overshoot duration is specified as a percentage of high time over the lifetime of the device. A DC signal is equivalent to 100% of the duty cycle. For example, a signal that overshoots to 3.95 V can be at 3.95 V for only ~21% over the lifetime of the device; for a device lifetime of 10 years, the overshoot duration amounts to ~2 years.

**Table 5. Maximum Allowed Overshoot During Transitions**

| Symbol     | Description      | Condition (V) | Overshoot Duration as %<br>@ $T_J = 100^\circ\text{C}$ | Unit |
|------------|------------------|---------------|--|------|
| $V_i$ (AC) | AC input voltage | 3.8           | 100  | %    |
|            |                  | 3.85          | 64   | %    |
|            |                  | 3.9           | 36   | %    |
|            |                  | 3.95          | 21   | %    |
|            |                  | 4             | 12   | %    |
|            |                  | 4.05          | 7  | %    |
|            |                  | 4.1           | 4  | %    |
|            |                  | 4.15          | 2  | %    |
|            |                  | 4.2           | 1  | %    |

**Figure 1. Stratix V Device Overshoot Duration**



**Table 6. Recommended Operating Conditions for Stratix V Devices (Part 2 of 2)**

| Symbol            | Description            | Condition    | Min <sup>(4)</sup> | Typ | Max <sup>(4)</sup> | Unit |
|-------------------|------------------------|--------------|--------------------|-----|--------------------|------|
| t <sub>RAMP</sub> | Power supply ramp time | Standard POR | 200 $\mu$ s        | —   | 100 ms             | —    |
|                   |                        | Fast POR     | 200 $\mu$ s        | —   | 4 ms               | —    |

**Notes to Table 6:**

- (1) V<sub>CCPD</sub> must be 2.5 V when V<sub>CCIO</sub> is 2.5, 1.8, 1.5, 1.35, 1.25 or 1.2 V. V<sub>CCPD</sub> must be 3.0 V when V<sub>CCIO</sub> is 3.0 V.
- (2) If you do not use the design security feature in Stratix V devices, connect V<sub>CCBAT</sub> to a 1.2- to 3.0-V power supply. Stratix V power-on-reset (POR) circuitry monitors V<sub>CCBAT</sub>. Stratix V devices will not exit POR if V<sub>CCBAT</sub> stays at logic low.
- (3) C2L and I2L can also be run at 0.90 V for legacy boards that were designed for the C2 and I2 speed grades.
- (4) The power supply value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 7 lists the transceiver power supply recommended operating conditions for Stratix V GX, GS, and GT devices.

**Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 1 of 2)**

| Symbol                            | Description   | Devices    | Minimum <sup>(4)</sup> | Typical | Maximum <sup>(4)</sup> | Unit |
|-----------------------------------|---|------------|------------------------|---------|------------------------|------|
| V <sub>CCA_GXBL</sub><br>(1), (3) | Transceiver channel PLL power supply (left side)  | GX, GS, GT | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GXBR</sub><br>(1), (3) | Transceiver channel PLL power supply (right side)   | GX, GS     | 2.85                   | 3.0     | 3.15                   | V    |
|                                   |   |            | 2.375                  | 2.5     | 2.625                  |      |
| V <sub>CCA_GTBR</sub>             | Transceiver channel PLL power supply (right side)   | GT         | 2.85                   | 3.0     | 3.15                   | V    |
| V <sub>CCHIP_L</sub>              | Transceiver hard IP power supply (left side; C1, C2, I2, and I3YY speed grades)               | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHIP_R</sub>              | Transceiver hard IP power supply (right side; C1, C2, I2, and I3YY speed grades)              | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver hard IP power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades) | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_L</sub>             | Transceiver PCS power supply (left side; C1, C2, I2, and I3YY speed grades)                   | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (left side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)      | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCHSSI_R</sub>             | Transceiver PCS power supply (right side; C1, C2, I2, and I3YY speed grades)                  | GX, GS, GT | 0.87                   | 0.9     | 0.93                   | V    |
|                                   | Transceiver PCS power supply (right side; C2L, C3, C4, I2L, I3, I3L, and I4 speed grades)     | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
| V <sub>CCR_GXBL</sub><br>(2)      | Receiver analog power supply (left side)  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                                   |   |            | 0.87                   | 0.90    | 0.93                   |      |
|                                   |   |            | 0.97                   | 1.0     | 1.03                   |      |
|                                   |   |            | 1.03                   | 1.05    | 1.07                   |      |

**Table 7. Recommended Transceiver Power Supply Operating Conditions for Stratix V GX, GS, and GT Devices (Part 2 of 2)**

| Symbol                 | Description  | Devices    | Minimum <sup>(4)</sup> | Typical | Maximum <sup>(4)</sup> | Unit |
|------------------------|--|------------|------------------------|---------|------------------------|------|
| $V_{CCR\_GXBR}$<br>(2) | Receiver analog power supply (right side)                    | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                        |  |            | 0.87                   | 0.90    | 0.93                   |      |
|                        |  |            | 0.97                   | 1.0     | 1.03                   |      |
|                        |  |            | 1.03                   | 1.05    | 1.07                   |      |
| $V_{CCR\_GTBR}$        | Receiver analog power supply for GT channels (right side)    | GT         | 1.02                   | 1.05    | 1.08                   | V    |
| $V_{CCT\_GXBL}$<br>(2) | Transmitter analog power supply (left side)                  | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                        |  |            | 0.87                   | 0.90    | 0.93                   |      |
|                        |  |            | 0.97                   | 1.0     | 1.03                   |      |
|                        |  |            | 1.03                   | 1.05    | 1.07                   |      |
| $V_{CCT\_GXBR}$<br>(2) | Transmitter analog power supply (right side)                 | GX, GS, GT | 0.82                   | 0.85    | 0.88                   | V    |
|                        |  |            | 0.87                   | 0.90    | 0.93                   |      |
|                        |  |            | 0.97                   | 1.0     | 1.03                   |      |
|                        |  |            | 1.03                   | 1.05    | 1.07                   |      |
| $V_{CCT\_GTBR}$        | Transmitter analog power supply for GT channels (right side) | GT         | 1.02                   | 1.05    | 1.08                   | V    |
| $V_{CCL\_GTBR}$        | Transmitter clock network power supply                       | GT         | 1.02                   | 1.05    | 1.08                   | V    |
| $V_{CCH\_GXBL}$        | Transmitter output buffer power supply (left side)           | GX, GS, GT | 1.425                  | 1.5     | 1.575                  | V    |
| $V_{CCH\_GXBR}$        | Transmitter output buffer power supply (right side)          | GX, GS, GT | 1.425                  | 1.5     | 1.575                  | V    |

**Notes to Table 7:**

- (1) This supply must be connected to 3.0 V if the CMU PLL, receiver CDR, or both, are configured at a base data rate > 6.5 Gbps. Up to 6.5 Gbps, you can connect this supply to either 3.0 V or 2.5 V.
- (2) Refer to Table 8 to select the correct power supply level for your design.
- (3) When using ATX PLLs, the supply must be 3.0 V.
- (4) This value describes the budget for the DC (static) power supply tolerance and does not include the dynamic tolerance requirements. Refer to the PDN tool for the additional budget for the dynamic tolerance requirements.

Table 8 shows the transceiver power supply voltage requirements for various conditions.

**Table 8. Transceiver Power Supply Voltage Requirements**

| Conditions  | Core Speed Grade                  | VCCR_GXB & VCCT_GXB <sup>(2)</sup> | VCCA_GXB | VCCH_GXB | Unit |
|---|-----------------------------------|------------------------------------|----------|----------|------|
| If BOTH of the following conditions are true:<br><ul style="list-style-type: none"> <li>■ Data rate &gt; 10.3 Gbps.</li> <li>■ DFE is used.</li> </ul>  | All                               | 1.05                               | 3.0      | 1.5      | V    |
| If ANY of the following conditions are true <sup>(1)</sup> :<br><ul style="list-style-type: none"> <li>■ ATX PLL is used.</li> <li>■ Data rate &gt; 6.5Gbps.</li> <li>■ DFE (data rate ≤ 10.3 Gbps), AEQ, or EyeQ feature is used.</li> </ul> | All                               | 1.0                                |          |          |      |
| If ALL of the following conditions are true:<br><ul style="list-style-type: none"> <li>■ ATX PLL is not used.</li> <li>■ Data rate ≤ 6.5Gbps.</li> <li>■ DFE, AEQ, and EyeQ are not used.</li> </ul>  | C1, C2, I2, and I3YY              | 0.90                               | 2.5      |          |      |
|   | C2L, C3, C4, I2L, I3, I3L, and I4 | 0.85                               | 2.5      |          |      |

**Notes to Table 8:**

- (1) Choose this power supply voltage requirement option if you plan to upgrade your design later with any of the listed conditions.
- (2) If the VCCR\_GXB and VCCT\_GXB supplies are set to 1.0 V or 1.05 V, they cannot be shared with the VCC core supply. If the VCCR\_GXB and VCCT\_GXB are set to either 0.90 V or 0.85 V, they can be shared with the VCC core supply.

## DC Characteristics

This section lists the supply current, I/O pin leakage current, input pin capacitance, on-chip termination tolerance, and hot socketing specifications.

### Supply Current

Supply current is the current drawn from the respective power rails used for power budgeting. Use the Excel-based Early Power Estimator (EPE) to get supply current estimates for your design because these currents vary greatly with the resources you use.



For more information about power estimation tools, refer to the *PowerPlay Early Power Estimator User Guide* and the *PowerPlay Power Analysis* chapter in the *Quartus II Handbook*.

**Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices <sup>(1)</sup> (Part 2 of 2)**

| Symbol   | Description  | Conditions                                    | Calibration Accuracy |            |            |            | Unit |
|--|--|---|----------------------|------------|------------|------------|------|
|  |  |   | C1                   | C2,I2      | C3,I3,I3YY | C4,I4      |      |
| 50-Ω R <sub>S</sub>                              | Internal series termination with calibration (50-Ω setting)                                      | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15        | ±15        | %    |
| 34-Ω and 40-Ω R <sub>S</sub>                     | Internal series termination with calibration (34-Ω and 40-Ω setting)                             | V <sub>CCIO</sub> = 1.5, 1.35, 1.25, 1.2 V    | ±15                  | ±15        | ±15        | ±15        | %    |
| 48-Ω, 60-Ω, 80-Ω, and 240-Ω R <sub>S</sub>       | Internal series termination with calibration (48-Ω, 60-Ω, 80-Ω, and 240-Ω setting)               | V <sub>CCIO</sub> = 1.2 V                     | ±15                  | ±15        | ±15        | ±15        | %    |
| 50-Ω R <sub>T</sub>                              | Internal parallel termination with calibration (50-Ω setting)                                    | V <sub>CCIO</sub> = 2.5, 1.8, 1.5, 1.2 V      | -10 to +40           | -10 to +40 | -10 to +40 | -10 to +40 | %    |
| 20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω R <sub>T</sub> | Internal parallel termination with calibration (20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω setting)       | V <sub>CCIO</sub> = 1.5, 1.35, 1.25 V         | -10 to +40           | -10 to +40 | -10 to +40 | -10 to +40 | %    |
| 60-Ω and 120-Ω R <sub>T</sub>                    | Internal parallel termination with calibration (60-Ω and 120-Ω setting)                          | V <sub>CCIO</sub> = 1.2                       | -10 to +40           | -10 to +40 | -10 to +40 | -10 to +40 | %    |
| 25-Ω R <sub>S_left_shift</sub>                   | Internal left shift series termination with calibration (25-Ω R <sub>S_left_shift</sub> setting) | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15        | ±15        | %    |

**Note to Table 11:**

(1) OCT calibration accuracy is valid at the time of calibration only.

Table 12 lists the Stratix V OCT without calibration resistance tolerance to PVT changes.

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 1 of 2)**

| Symbol                      | Description  | Conditions                        | Resistance Tolerance |       |              |        | Unit |
|-----------------------------|--|-----------------------------------|----------------------|-------|--------------|--------|------|
|                             |  |                                   | C1                   | C2,I2 | C3, I3, I3YY | C4, I4 |      |
| 25-Ω R, 50-Ω R <sub>S</sub> | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 3.0 and 2.5 V | ±30                  | ±30   | ±40          | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30   | ±40          | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35   | ±50          | ±50    | %    |

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 2 of 2)**

| Symbol               | Description  | Conditions                        | Resistance Tolerance |        |              |        | Unit |
|----------------------|--|-----------------------------------|----------------------|--------|--------------|--------|------|
|                      |  |                                   | C1                   | C2, I2 | C3, I3, I3YY | C4, I4 |      |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30    | ±40          | ±40    | %    |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35    | ±50          | ±50    | %    |
| 100-Ω R <sub>D</sub> | Internal differential termination (100-Ω setting)              | V <sub>CCPD</sub> = 2.5 V         | ±25                  | ±25    | ±25          | ±25    | %    |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

**Equation 1. OCT Variation Without Recalibration for Stratix V Devices <sup>(1), (2), (3), (4), (5), (6)</sup>**

$$R_{OCT} = R_{SCAL} \left( 1 + \left\langle \frac{dR}{dT} \times \Delta T \right\rangle \pm \left\langle \frac{dR}{dV} \times \Delta V \right\rangle \right)$$

**Notes to Equation 1:**

- (1) The R<sub>OCT</sub> value shows the range of OCT resistance with the variation of temperature and V<sub>CCIO</sub>.
- (2) R<sub>SCAL</sub> is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V<sub>CCIO</sub> at power-up.
- (5) dR/dT is the percentage change of R<sub>SCAL</sub> with temperature.
- (6) dR/dV is the percentage change of R<sub>SCAL</sub> with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2) <sup>(1)</sup>**

| Symbol | Description                                      | V <sub>CCIO</sub> (V) | Typical | Unit   |
|--------|--|-----------------------|---------|--------|
| dR/dV  | OCT variation with voltage without recalibration | 3.0                   | 0.0297  | % / mV |
|        |  | 2.5                   | 0.0344  |        |
|        |  | 1.8                   | 0.0499  |        |
|        |  | 1.5                   | 0.0744  |        |
|        |  | 1.2                   | 0.1241  |        |

**Table 18. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Stratix V Devices**

| I/O Standard            | $V_{CCIO}$ (V) |      |       | $V_{REF}$ (V)     |                  |                   | $V_{TT}$ (V)      |                  |                   |
|-------------------------|----------------|------|-------|-------------------|------------------|-------------------|-------------------|------------------|-------------------|
|                         | Min            | Typ  | Max   | Min               | Typ              | Max               | Min               | Typ              | Max               |
| SSTL-2<br>Class I, II   | 2.375          | 2.5  | 2.625 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $V_{REF} - 0.04$  | $V_{REF}$        | $V_{REF} + 0.04$  |
| SSTL-18<br>Class I, II  | 1.71           | 1.8  | 1.89  | 0.833             | 0.9              | 0.969             | $V_{REF} - 0.04$  | $V_{REF}$        | $V_{REF} + 0.04$  |
| SSTL-15<br>Class I, II  | 1.425          | 1.5  | 1.575 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-135<br>Class I, II | 1.283          | 1.35 | 1.418 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-125<br>Class I, II | 1.19           | 1.25 | 1.26  | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-12<br>Class I, II  | 1.14           | 1.20 | 1.26  | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| HSTL-18<br>Class I, II  | 1.71           | 1.8  | 1.89  | 0.85              | 0.9              | 0.95              | —                 | $V_{CCIO}/2$     | —                 |
| HSTL-15<br>Class I, II  | 1.425          | 1.5  | 1.575 | 0.68              | 0.75             | 0.9               | —                 | $V_{CCIO}/2$     | —                 |
| HSTL-12<br>Class I, II  | 1.14           | 1.2  | 1.26  | $0.47 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.53 * V_{CCIO}$ | —                 | $V_{CCIO}/2$     | —                 |
| HSUL-12                 | 1.14           | 1.2  | 1.3   | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | —                 | —                | —                 |

**Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 1 of 2)**

| I/O Standard            | $V_{IL(DC)}$ (V) |                   | $V_{IH(DC)}$ (V)  |                  | $V_{IL(AC)}$ (V)  | $V_{IH(AC)}$ (V)  | $V_{OL}$ (V)     | $V_{OH}$ (V)      | $I_{OI}$ (mA) | $I_{OH}$ (mA) |
|-------------------------|------------------|-------------------|-------------------|------------------|-------------------|-------------------|------------------|-------------------|---------------|---------------|
|                         | Min              | Max               | Min               | Max              | Max               | Min               | Max              | Min               |               |               |
| SSTL-2<br>Class I       | -0.3             | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $V_{CCIO} + 0.3$ | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | $V_{TT} - 0.608$ | $V_{TT} + 0.608$  | 8.1           | -8.1          |
| SSTL-2<br>Class II      | -0.3             | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $V_{CCIO} + 0.3$ | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | $V_{TT} - 0.81$  | $V_{TT} + 0.81$   | 16.2          | -16.2         |
| SSTL-18<br>Class I      | -0.3             | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | $V_{CCIO} + 0.3$ | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | $V_{TT} - 0.603$ | $V_{TT} + 0.603$  | 6.7           | -6.7          |
| SSTL-18<br>Class II     | -0.3             | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | $V_{CCIO} + 0.3$ | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | 0.28             | $V_{CCIO} - 0.28$ | 13.4          | -13.4         |
| SSTL-15<br>Class I      | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | 8             | -8            |
| SSTL-15<br>Class II     | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | 16            | -16           |
| SSTL-135<br>Class I, II | —                | $V_{REF} - 0.09$  | $V_{REF} + 0.09$  | —                | $V_{REF} - 0.16$  | $V_{REF} + 0.16$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |
| SSTL-125<br>Class I, II | —                | $V_{REF} - 0.85$  | $V_{REF} + 0.85$  | —                | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |
| SSTL-12<br>Class I, II  | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |



**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 4 of 7)**

| Symbol/<br>Description                                     | Conditions  | Transceiver Speed<br>Grade 1 |           |     | Transceiver Speed<br>Grade 2 |           |     | Transceiver Speed<br>Grade 3 |           |     | Unit |
|--|---|------------------------------|-----------|-----|------------------------------|-----------|-----|------------------------------|-----------|-----|------|
|  |   | Min                          | Typ       | Max | Min                          | Typ       | Max | Min                          | Typ       | Max |      |
| Differential on-chip termination resistors <sup>(21)</sup> | 85-Ω setting  | —                            | 85 ± 30%  | —   | —                            | 85 ± 30%  | —   | —                            | 85 ± 30%  | —   | Ω    |
|  | 100-Ω setting   | —                            | 100 ± 30% | —   | —                            | 100 ± 30% | —   | —                            | 100 ± 30% | —   | Ω    |
|  | 120-Ω setting   | —                            | 120 ± 30% | —   | —                            | 120 ± 30% | —   | —                            | 120 ± 30% | —   | Ω    |
|  | 150-Ω setting   | —                            | 150 ± 30% | —   | —                            | 150 ± 30% | —   | —                            | 150 ± 30% | —   | Ω    |
| V <sub>ICM</sub><br>(AC and DC coupled)                    | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V full bandwidth   | —                            | 600       | —   | —                            | 600       | —   | —                            | 600       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 0.85 V or 0.9 V half bandwidth   | —                            | 600       | —   | —                            | 600       | —   | —                            | 600       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 1.0 V/1.05 V full bandwidth      | —                            | 700       | —   | —                            | 700       | —   | —                            | 700       | —   | mV   |
|  | V <sub>CCR_GXB</sub> = 1.0 V half bandwidth             | —                            | 750       | —   | —                            | 750       | —   | —                            | 750       | —   | mV   |
| t <sub>LTR</sub> <sup>(11)</sup>                           | —   | —                            | —         | 10  | —                            | —         | 10  | —                            | —         | 10  | μs   |
| t <sub>LTD</sub> <sup>(12)</sup>                           | —   | 4                            | —         | —   | 4                            | —         | —   | 4                            | —         | —   | μs   |
| t <sub>LTD_manual</sub> <sup>(13)</sup>                    | —   | 4                            | —         | —   | 4                            | —         | —   | 4                            | —         | —   | μs   |
| t <sub>LTR_LTD_manual</sub> <sup>(14)</sup>                | —   | 15                           | —         | —   | 15                           | —         | —   | 15                           | —         | —   | μs   |
| Run Length   | —   | —                            | —         | 200 | —                            | —         | 200 | —                            | —         | 200 | UI   |
| Programmable equalization (AC Gain) <sup>(10)</sup>        | Full bandwidth (6.25 GHz)<br>Half bandwidth (3.125 GHz) | —                            | —         | 16  | —                            | —         | 16  | —                            | —         | 16  | dB   |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions   | Transceiver<br>Speed Grade 2   |           |      | Transceiver<br>Speed Grade 3 |           |      | Unit |
|--|--|--|-----------|------|------------------------------|-----------|------|------|
|  |  | Min  | Typ       | Max  | Min                          | Typ       | Max  |      |
| Reference Clock  |  |  |           |      |                              |           |      |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                    | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS,<br>and HCSL |           |      |                              |           |      |      |
|  | RX reference<br>clock pin                              | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                   |           |      |                              |           |      |      |
| Input Reference Clock<br>Frequency (CMU<br>PLL) <sup>(6)</sup> | —  | 40   | —         | 710  | 40                           | —         | 710  | MHz  |
| Input Reference Clock<br>Frequency (ATX PLL) <sup>(6)</sup>    | —  | 100  | —         | 710  | 100                          | —         | 710  | MHz  |
| Rise time  | 20% to 80%   | —  | —         | 400  | —                            | —         | 400  | ps   |
| Fall time  | 80% to 20%   | —  | —         | 400  | —                            | —         | 400  |      |
| Duty cycle   | —  | 45   | —         | 55   | 45                           | —         | 55   | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express<br>(PCIe)                                  | 30   | —         | 33   | 30                           | —         | 33   | kHz  |
| Spread-spectrum<br>downspread                                  | PCIe   | —  | 0 to −0.5 | —    | —                            | 0 to −0.5 | —    | %    |
| On-chip termination<br>resistors <sup>(19)</sup>               | —  | —  | 100       | —    | —                            | 100       | —    | Ω    |
| Absolute V <sub>MAX</sub> <sup>(3)</sup>                       | Dedicated<br>reference<br>clock pin                    | —  | —         | 1.6  | —                            | —         | 1.6  | V    |
|  | RX reference<br>clock pin                              | —  | —         | 1.2  | —                            | —         | 1.2  |      |
| Absolute V <sub>MIN</sub>                                      | —  | -0.4   | —         | —    | -0.4                         | —         | —    | V    |
| Peak-to-peak<br>differential input<br>voltage                  | —  | 200  | —         | 1600 | 200                          | —         | 1600 | mV   |
| V <sub>ICM</sub> (AC coupled)                                  | Dedicated<br>reference<br>clock pin                    | 1050/1000 <sup>(2)</sup>   |           |      | 1050/1000 <sup>(2)</sup>     |           |      | mV   |
|  | RX reference<br>clock pin                              | 1.0/0.9/0.85 <sup>(22)</sup>   |           |      | 1.0/0.9/0.85 <sup>(22)</sup> |           |      | V    |
| V <sub>ICM</sub> (DC coupled)                                  | HCSL I/O<br>standard for<br>PCIe<br>reference<br>clock | 250  | —         | 550  | 250                          | —         | 550  | mV   |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 3 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                      | Transceiver<br>Speed Grade 2 |               |        | Transceiver<br>Speed Grade 3 |               |        | Unit      |
|--|---------------------------------|------------------------------|---------------|--------|------------------------------|---------------|--------|-----------|
|  |                                 | Min                          | Typ           | Max    | Min                          | Typ           | Max    |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| Differential on-chip termination resistors for GX channels <sup>(19)</sup> | 85- $\Omega$ setting            | —                            | 85 $\pm$ 30%  | —      | —                            | 85 $\pm$ 30%  | —      | $\Omega$  |
|  | 100- $\Omega$ setting           | —                            | 100 $\pm$ 30% | —      | —                            | 100 $\pm$ 30% | —      | $\Omega$  |
|  | 120- $\Omega$ setting           | —                            | 120 $\pm$ 30% | —      | —                            | 120 $\pm$ 30% | —      | $\Omega$  |
|  | 150- $\Omega$ setting           | —                            | 150 $\pm$ 30% | —      | —                            | 150 $\pm$ 30% | —      | $\Omega$  |
| V <sub>ICM</sub> (AC coupled)  | GT channels                     | —                            | 650           | —      | —                            | 650           | —      | mV        |
| VICM (AC and DC coupled) for GX Channels                                   | VCCR_GXB = 0.85 V or 0.9 V      | —                            | 600           | —      | —                            | 600           | —      | mV        |
|  | VCCR_GXB = 1.0 V full bandwidth | —                            | 700           | —      | —                            | 700           | —      | mV        |
|  | VCCR_GXB = 1.0 V half bandwidth | —                            | 750           | —      | —                            | 750           | —      | mV        |
| t <sub>LTR</sub> <sup>(9)</sup>  | —                               | —                            | —             | 10     | —                            | —             | 10     | $\mu$ s   |
| t <sub>LTD</sub> <sup>(10)</sup>   | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTD_manual</sub> <sup>(11)</sup>                                    | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTR_LTD_manual</sub> <sup>(12)</sup>                                | —                               | 15                           | —             | —      | 15                           | —             | —      | $\mu$ s   |
| Run Length   | GT channels                     | —                            | —             | 72     | —                            | —             | 72     | CID       |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| CDR PPM  | GT channels                     | —                            | —             | 1000   | —                            | —             | 1000   | $\pm$ PPM |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable equalization (AC Gain) <sup>(5)</sup>                         | GT channels                     | —                            | —             | 14     | —                            | —             | 14     | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable DC gain <sup>(6)</sup>  | GT channels                     | —                            | —             | 7.5    | —                            | —             | 7.5    | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| <b>Transmitter</b>   |                                 |                              |               |        |                              |               |        |           |
| Supported I/O Standards  | —                               | 1.4-V and 1.5-V PCML         |               |        |                              |               |        |           |
| Data rate (Standard PCS)   | GX channels                     | 600                          | —             | 8500   | 600                          | —             | 8500   | Mbps      |
| Data rate (10G PCS)  | GX channels                     | 600                          | —             | 12,500 | 600                          | —             | 12,500 | Mbps      |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 5 of 5) <sup>(1)</sup>**

| Symbol/<br>Description          | Conditions | Transceiver<br>Speed Grade 2 |     |     | Transceiver<br>Speed Grade 3 |     |     | Unit |
|---------------------------------|------------|------------------------------|-----|-----|------------------------------|-----|-----|------|
|                                 |            | Min                          | Typ | Max | Min                          | Typ | Max |      |
| $t_{pll\_lock}$ <sup>(14)</sup> | —          | —                            | —   | 10  | —                            | —   | 10  | μs   |

**Notes to Table 28:**

- (1) Speed grades shown refer to the PMA Speed Grade in the device ordering code. The maximum data rate could be restricted by the Core/PCS speed grade. Contact your Altera Sales Representative for the maximum data rate specifications in each speed grade combination offered. For more information about device ordering codes, refer to the *Stratix V Device Overview*.
- (2) The reference clock common mode voltage is equal to the VCCR\_GXB power supply level.
- (3) The device cannot tolerate prolonged operation at this absolute maximum.
- (4) The differential eye opening specification at the receiver input pins assumes that receiver equalization is disabled. If you enable receiver equalization, the receiver circuitry can tolerate a lower minimum eye opening, depending on the equalization level.
- (5) Refer to Figure 5 for the GT channel AC gain curves. The total effective AC gain is the AC gain minus the DC gain.
- (6) Refer to Figure 6 for the GT channel DC gain curves.
- (7) CFP2 optical modules require the host interface to have the receiver data pins differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (8) Specifications for this parameter are the same as for Stratix V GX and GS devices. See Table 23 for specifications.
- (9)  $t_{LTR}$  is the time required for the receive CDR to lock to the input reference clock frequency after coming out of reset.
- (10)  $t_{LTD}$  is time required for the receiver CDR to start recovering valid data after the  $rx\_is\_lockedto\ data$  signal goes high.
- (11)  $t_{LTD\_manual}$  is the time required for the receiver CDR to start recovering valid data after the  $rx\_is\_lockedto\ data$  signal goes high when the CDR is functioning in the manual mode.
- (12)  $t_{LTR\_LTD\_manual}$  is the time the receiver CDR must be kept in lock to reference (LTR) mode after the  $rx\_is\_lockedto\ ref$  signal goes high when the CDR is functioning in the manual mode.
- (13)  $tp11\_powerdown$  is the PLL powerdown minimum pulse width.
- (14)  $tp11\_lock$  is the time required for the transmitter CMU/ATX PLL to lock to the input reference clock frequency after coming out of reset.
- (15) To calculate the REFCLK rms phase jitter requirement for PCIe at reference clock frequencies other than 100 MHz, use the following formula:  
REFCLK rms phase jitter at f(MHz) = REFCLK rms phase jitter at 100 MHz × 100/f.
- (16) The maximum peak to peak differential input voltage  $V_{ID}$  after device configuration is equal to  $4 \times (\text{absolute } V_{MAX} \text{ for receiver pin} - V_{ICM})$ .
- (17) For ES devices, RREF is 2000 Ω ±1%.
- (18) To calculate the REFCLK phase noise requirement at frequencies other than 622 MHz, use the following formula: REFCLK phase noise at f(MHz) = REFCLK phase noise at 622 MHz + 20\*log(f/622).
- (19) SFP/+ optical modules require the host interface to have RD+/- differentially terminated with 100 Ω. The internal OCT feature is available after the Stratix V FPGA configuration is completed. Altera recommends that FPGA configuration is completed before inserting the optical module. Otherwise, minimize unnecessary removal and insertion with unconfigured devices.
- (20) Refer to Figure 4.
- (21) For oversampling design to support data rates less than the minimum specification, the CDR needs to be in LTR mode only.
- (22) This supply follows VCCR\_GXB for both GX and GT channels.
- (23) When you use fPLL as a TXPLL of the transceiver.

## PLL Specifications

Table 31 lists the Stratix V PLL specifications when operating in both the commercial junction temperature range (0° to 85°C) and the industrial junction temperature range (–40° to 100°C).

**Table 31. PLL Specifications for Stratix V Devices (Part 1 of 3)**

| Symbol                   | Parameter  | Min | Typ | Max                | Unit |
|--------------------------|--|-----|-----|--------------------|------|
| $f_{IN}$                 | Input clock frequency (C1, C2, C2L, I2, and I2L speed grades)  | 5   | —   | 800 <sup>(1)</sup> | MHz  |
|                          | Input clock frequency (C3, I3, I3L, and I3YY speed grades)   | 5   | —   | 800 <sup>(1)</sup> | MHz  |
|                          | Input clock frequency (C4, I4 speed grades)  | 5   | —   | 650 <sup>(1)</sup> | MHz  |
| $f_{INPFD}$              | Input frequency to the PFD   | 5   | —   | 325                | MHz  |
| $f_{FINPFD}$             | Fractional Input clock frequency to the PFD  | 50  | —   | 160                | MHz  |
| $f_{VCO}$ <sup>(9)</sup> | PLL VCO operating range (C1, C2, C2L, I2, I2L speed grades)  | 600 | —   | 1600               | MHz  |
|                          | PLL VCO operating range (C3, I3, I3L, I3YY speed grades)   | 600 | —   | 1600               | MHz  |
|                          | PLL VCO operating range (C4, I4 speed grades)  | 600 | —   | 1300               | MHz  |
| $t_{EINDUTY}$            | Input clock or external feedback clock input duty cycle  | 40  | —   | 60                 | %    |
| $f_{OUT}$                | Output frequency for an internal global or regional clock (C1, C2, C2L, I2, I2L speed grades)            | —   | —   | 717 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an internal global or regional clock (C3, I3, I3L speed grades)                     | —   | —   | 650 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an internal global or regional clock (C4, I4 speed grades)                          | —   | —   | 580 <sup>(2)</sup> | MHz  |
| $f_{OUT\_EXT}$           | Output frequency for an external clock output (C1, C2, C2L, I2, I2L speed grades)                        | —   | —   | 800 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an external clock output (C3, I3, I3L speed grades)                                 | —   | —   | 667 <sup>(2)</sup> | MHz  |
|                          | Output frequency for an external clock output (C4, I4 speed grades)                                      | —   | —   | 553 <sup>(2)</sup> | MHz  |
| $t_{OUTDUTY}$            | Duty cycle for a dedicated external clock output (when set to 50%)                                       | 45  | 50  | 55                 | %    |
| $t_{FCOMP}$              | External feedback clock compensation time  | —   | —   | 10                 | ns   |
| $f_{DYCONFIGCLK}$        | Dynamic Configuration Clock used for <code>mgmt_clk</code> and <code>scanclk</code>                      | —   | —   | 100                | MHz  |
| $t_{LOCK}$               | Time required to lock from the end-of-device configuration or deassertion of <code>areset</code>         | —   | —   | 1                  | ms   |
| $t_{DLOCK}$              | Time required to lock dynamically (after switchover or reconfiguring any non-post-scale counters/delays) | —   | —   | 1                  | ms   |
| $f_{CLBW}$               | PLL closed-loop low bandwidth  | —   | 0.3 | —                  | MHz  |
|                          | PLL closed-loop medium bandwidth   | —   | 1.5 | —                  | MHz  |
|                          | PLL closed-loop high bandwidth <sup>(7)</sup>  | —   | 4   | —                  | MHz  |
| $t_{PLL\_PSERR}$         | Accuracy of PLL phase shift  | —   | —   | ±50                | ps   |
| $t_{ARESET}$             | Minimum pulse width on the <code>areset</code> signal  | 10  | —   | —                  | ns   |

**Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 2 of 2)**

| Mode                   | Peformance |         |         |     |               |     |     | Unit |
|------------------------|------------|---------|---------|-----|---------------|-----|-----|------|
|                        | C1         | C2, C2L | I2, I2L | C3  | I3, I3L, I3YY | C4  | I4  |      |
| Modes using Three DSPs |            |         |         |     |               |     |     |      |
| One complex 18 x 25    | 425        | 425     | 415     | 340 | 340           | 275 | 265 | MHz  |
| Modes using Four DSPs  |            |         |         |     |               |     |     |      |
| One complex 27 x 27    | 465        | 465     | 465     | 380 | 380           | 300 | 290 | MHz  |

### Memory Block Specifications

Table 33 lists the Stratix V memory block specifications.

**Table 33. Memory Block Performance Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 2)**

| Memory | Mode                                       | Resources Used |        | Performance |         |     |     |         |               |     | Unit |
|--------|--|----------------|--------|-------------|---------|-----|-----|---------|---------------|-----|------|
|        |  | ALUTs          | Memory | C1          | C2, C2L | C3  | C4  | I2, I2L | I3, I3L, I3YY | I4  |      |
| MLAB   | Single port, all supported widths          | 0              | 1      | 450         | 450     | 400 | 315 | 450     | 400           | 315 | MHz  |
|        | Simple dual-port, x32/x64 depth            | 0              | 1      | 450         | 450     | 400 | 315 | 450     | 400           | 315 | MHz  |
|        | Simple dual-port, x16 depth <sup>(3)</sup> | 0              | 1      | 675         | 675     | 533 | 400 | 675     | 533           | 400 | MHz  |
|        | ROM, all supported widths                  | 0              | 1      | 600         | 600     | 500 | 450 | 600     | 500           | 450 | MHz  |

Figure 7 shows the dynamic phase alignment (DPA) lock time specifications with the DPA PLL calibration option enabled.

**Figure 7. DPA Lock Time Specification with DPA PLL Calibration Enabled**

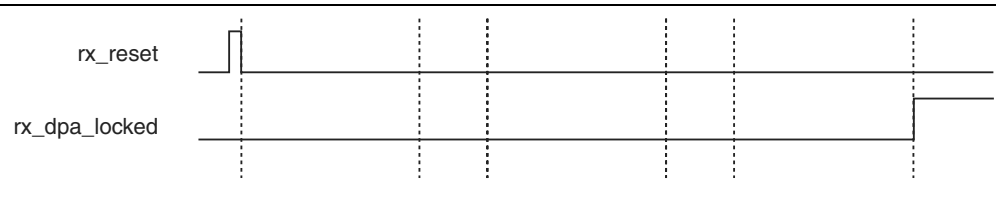


Table 37 lists the DPA lock time specifications for Stratix V devices.

**Table 37. DPA Lock Time Specifications for Stratix V GX Devices Only <sup>(1), (2), (3)</sup>**

| Standard           | Training Pattern     | Number of Data Transitions in One Repetition of the Training Pattern | Number of Repetitions per 256 Data Transitions <sup>(4)</sup> | Maximum              |
|--------------------|----------------------|--|---|----------------------|
| SPI-4              | 00000000001111111111 | 2  | 128   | 640 data transitions |
| Parallel Rapid I/O | 00001111             | 2  | 128   | 640 data transitions |
|                    | 10010000             | 4  | 64  | 640 data transitions |
| Miscellaneous      | 10101010             | 8  | 32  | 640 data transitions |
|                    | 01010101             | 8  | 32  | 640 data transitions |

**Notes to Table 37:**

- (1) The DPA lock time is for one channel.
- (2) One data transition is defined as a 0-to-1 or 1-to-0 transition.
- (3) The DPA lock time stated in this table applies to both commercial and industrial grade.
- (4) This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

Figure 8 shows the LVDS soft-clock data recovery (CDR)/DPA sinusoidal jitter tolerance specification for a data rate  $\geq 1.25$  Gbps. Table 38 lists the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate  $\geq 1.25$  Gbps.

**Figure 8. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate  $\geq 1.25$  Gbps**



**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GS      | D3          | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | D4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | D5          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | D6          | 4                            | 100        | 0.741               | 32                                   | 100        | 0.093               |
|         | D8          | 4                            | 100        | 0.741               | 32                                   | 100        | 0.093               |
| E       | E9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | EB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |

**Notes to Table 48:**

(1) DCLK frequency of 100 MHz using external CLKUSR.

(2) Max FPGA FPP bandwidth may exceed bandwidth available from some external storage or control logic.

## Fast Passive Parallel Configuration Timing

This section describes the fast passive parallel (FPP) configuration timing parameters for Stratix V devices.

### DCLK-to-DATA[] Ratio for FPP Configuration

FPP configuration requires a different DCLK-to-DATA [] ratio when you enable the design security, decompression, or both features. Table 49 lists the DCLK-to-DATA [] ratio for each combination.

**Table 49. DCLK-to-DATA[] Ratio <sup>(1)</sup> (Part 1 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|----------------------|---------------|-----------------|----------------------|
| FPP ×8               | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 1                    |
|                      | Enabled       | Disabled        | 2                    |
|                      | Enabled       | Enabled         | 2                    |
| FPP ×16              | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 2                    |
|                      | Enabled       | Disabled        | 4                    |
|                      | Enabled       | Enabled         | 4                    |





Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is 1.

**Table 50. FPP Timing Parameters for Stratix V Devices <sup>(1)</sup>**

| Symbol                            | Parameter   | Minimum  | Maximum              | Units |
|-----------------------------------|---|--|----------------------|-------|
| t <sub>CF2CD</sub>                | nCONFIG low to CONF_DONE low                      | —  | 600                  | ns    |
| t <sub>CF2ST0</sub>               | nCONFIG low to nSTATUS low                        | —  | 600                  | ns    |
| t <sub>CFG</sub>                  | nCONFIG low pulse width                           | 2  | —                    | μs    |
| t <sub>STATUS</sub>               | nSTATUS low pulse width                           | 268  | 1,506 <sup>(2)</sup> | μs    |
| t <sub>CF2ST1</sub>               | nCONFIG high to nSTATUS high                      | —  | 1,506 <sup>(3)</sup> | μs    |
| t <sub>CF2CK</sub> <sup>(6)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506  | —                    | μs    |
| t <sub>ST2CK</sub> <sup>(6)</sup> | nSTATUS high to first rising edge of DCLK         | 2  | —                    | μs    |
| t <sub>DSU</sub>                  | DATA [] setup time before rising edge on DCLK     | 5.5  | —                    | ns    |
| t <sub>DH</sub>                   | DATA [] hold time after rising edge on DCLK       | 0  | —                    | ns    |
| t <sub>CH</sub>                   | DCLK high time                                    | $0.45 \times 1/f_{\text{MAX}}$                             | —                    | s     |
| t <sub>CL</sub>                   | DCLK low time                                     | $0.45 \times 1/f_{\text{MAX}}$                             | —                    | s     |
| t <sub>CLK</sub>                  | DCLK period                                       | $1/f_{\text{MAX}}$   | —                    | s     |
| f <sub>MAX</sub>                  | DCLK frequency (FPP ×8/×16)                       | —  | 125                  | MHz   |
|                                   | DCLK frequency (FPP ×32)                          | —  | 100                  | MHz   |
| t <sub>CD2UM</sub>                | CONF_DONE high to user mode <sup>(4)</sup>        | 175  | 437                  | μs    |
| t <sub>CD2CU</sub>                | CONF_DONE high to CLKUSR enabled                  | 4 × maximum DCLK period                                    | —                    | —     |
| t <sub>CD2UMC</sub>               | CONF_DONE high to user mode with CLKUSR option on | t <sub>CD2CU</sub> + (8576 × CLKUSR period) <sup>(5)</sup> | —                    | —     |

**Notes to Table 50:**

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (6) If nSTATUS is monitored, follow the t<sub>ST2CK</sub> specification. If nSTATUS is not monitored, follow the t<sub>CF2CK</sub> specification.

### FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

## Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

**Table 52. DCLK Frequency Specification in the AS Configuration Scheme <sup>(1), (2)</sup>**

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3     | 7.9     | 12.5    | MHz  |
| 10.6    | 15.7    | 25.0    | MHz  |
| 21.3    | 31.4    | 50.0    | MHz  |
| 42.6    | 62.9    | 100.0   | MHz  |

**Notes to Table 52:**

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

**Figure 14. AS Configuration Timing**



**Notes to Figure 14:**

- (1) If you are using AS ×4 mode, this signal represents the AS\_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

**Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol   | Parameter                                   | Minimum | Maximum | Units |
|----------|---|---------|---------|-------|
| $t_{CO}$ | DCLK falling edge to AS_DATA0/ASDO output   | —       | 2       | ns    |
| $t_{SU}$ | Data setup time before falling edge on DCLK | 1.5     | —       | ns    |
| $t_H$    | Data hold time after falling edge on DCLK   | 0       | —       | ns    |

**Table 58. IOE Programmable Delay for Stratix V Devices (Part 2 of 2)**

| Parameter<br>(1) | Available<br>Settings | Min<br>Offset<br>(2) | Fast Model |            | Slow Model |       |       |       |       |             |       |      |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
|                  |                       |                      | Industrial | Commercial | C1         | C2    | C3    | C4    | I2    | I3,<br>I3YY | I4    | Unit |
| D3               | 8                     | 0                    | 1.587      | 1.699      | 2.793      | 2.793 | 2.992 | 3.192 | 2.811 | 3.047       | 3.257 | ns   |
| D4               | 64                    | 0                    | 0.464      | 0.492      | 0.838      | 0.838 | 0.924 | 1.011 | 0.843 | 0.920       | 1.006 | ns   |
| D5               | 64                    | 0                    | 0.464      | 0.493      | 0.838      | 0.838 | 0.924 | 1.011 | 0.844 | 0.921       | 1.006 | ns   |
| D6               | 32                    | 0                    | 0.229      | 0.244      | 0.415      | 0.415 | 0.458 | 0.503 | 0.418 | 0.456       | 0.499 | ns   |

**Notes to Table 58:**

- (1) You can set this value in the Quartus II software by selecting **D1**, **D2**, **D3**, **D5**, and **D6** in the **Assignment Name** column of **Assignment Editor**.
- (2) Minimum offset does not include the intrinsic delay.

## Programmable Output Buffer Delay

Table 59 lists the delay chain settings that control the rising and falling edge delays of the output buffer. The default delay is 0 ps.

**Table 59. Programmable Output Buffer Delay for Stratix V Devices (1)**

| Symbol              | Parameter                        | Typical     | Unit |
|---------------------|----------------------------------|-------------|------|
| D <sub>OUTBUF</sub> | Rising and/or falling edge delay | 0 (default) | ps   |
|                     |                                  | 25          | ps   |
|                     |                                  | 50          | ps   |
|                     |                                  | 75          | ps   |

**Note to Table 59:**

- (1) You can set the programmable output buffer delay in the Quartus II software by setting the **Output Buffer Delay Control** assignment to either positive, negative, or both edges, with the specific values stated here (in ps) for the **Output Buffer Delay** assignment.

## Glossary

Table 60 lists the glossary for this chapter.

**Table 60. Glossary (Part 1 of 4)**

| Letter | Subject              | Definitions   |
|--------|----------------------|---|
| A      | —                    | —   |
| B      |                      |   |
| C      |                      |   |
| D      | —                    | —   |
| E      | —                    | —   |
| F      | f <sub>HCLK</sub>    | Left and right PLL input clock frequency.   |
|        | f <sub>HSDR</sub>    | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDR</sub> = 1/TUI), non-DPA. |
|        | f <sub>HSDRDPA</sub> | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDRDPA</sub> = 1/TUI), DPA.  |

**Table 60. Glossary (Part 2 of 4)**

| Letter                | Subject                    | Definitions  |
|-----------------------|----------------------------|--|
| G<br>H<br>I           | —                          | —  |
| J                     | JTAG Timing Specifications | <p>High-speed I/O block—Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p>  |
| K<br>L<br>M<br>N<br>O | —                          | —  |
| P                     | PLL Specifications         | <p><b>Diagram of PLL Specifications</b> <sup>(1)</sup></p> <p><b>Note:</b></p> <p>(1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p> |
| Q                     | —                          | —  |
| R                     | R <sub>L</sub>             | Receiver differential input discrete resistor (external to the Stratix V device).  |